

**MAGNETIC POSITION DETECTION APPARATUS FOR MICRO
MACHINED OPTICAL ELEMENT**

CROSS REFERENCE TO RELATED APPLICATION

5 This application is a division of and claims priority from United States Patent Application
Serial No. 09/851587, by Murali Chaparala entitled "MAGNETIC POSITION
DETECTION FOR MICRO MACHINED OPTICAL ELEMENTS," Agent's Docket No.
ONX-117A, filed 5/8/2001, and which is incorporated herein by reference.

FIELD OF THE INVENTION

10 This invention relates to optical communications and more particularly to measuring the
position of micro machined optical elements.

BACKGROUND OF THE INVENTION

15 MEMS free-space optical switches can be categorized into two major branches: the planar
matrix (2-dimensional) approach, and the beam-steering (3-dimensional) approach. The 2D
approach typically involves mirrors that move between on and off position, while the 3-D
approach typically involves mirrors that tilt over a continuous range of angles to deflect
optical signals from one fiber array to another. The 3-D approach relies on accurate control
of mirror position to minimize optical loss from the coupling of photons from one fiber to
another.

20 Fiber optic communications systems are subject to faults that interrupt signal traffic. The
fault may occur in the optical switch or in some other part of the system. In both switching
approaches it is useful for, fault detection purposes, to know whether a given mirror actuating
mechanism has failed. One way to determine this is to sense the position of the mirror to
determine whether it is in a desired state. If the mirror is not in the desired state, a fault in the
mirror mechanism may be determined and signal traffic may be routed around the faulty
25 mirror.

Most of these MEMS optical elements have used some variation of sensing capacitance or
piezoresistance as a means of detecting the angular position of the optical element. In the 2D
approach, to perform accurate capacitance sensing the signal lines have to be shielded which